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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

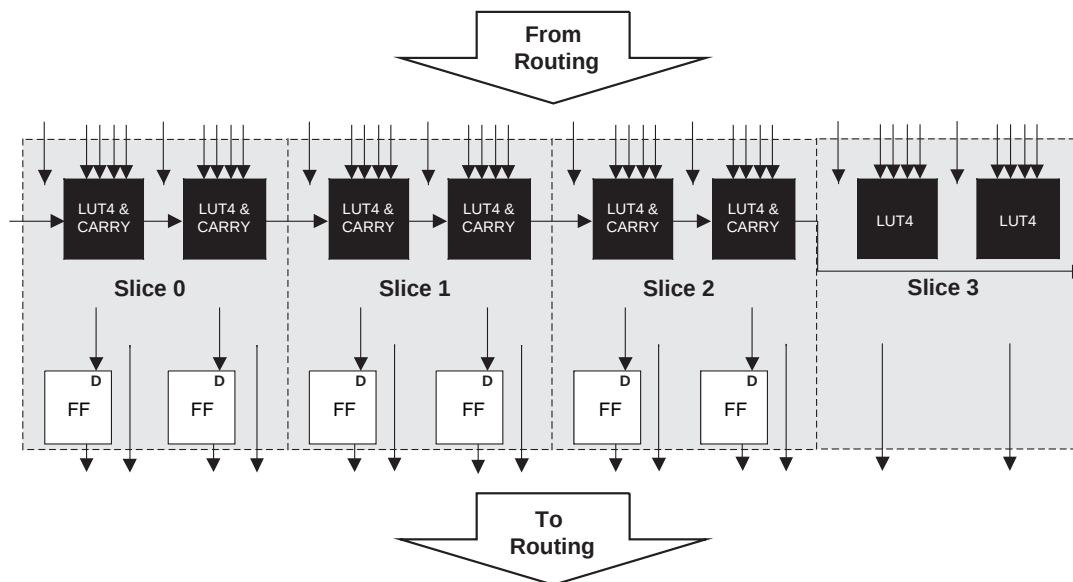
Product Status	Not For New Designs
Number of LABs/CLBs	2625
Number of Logic Elements/Cells	21000
Total RAM Bits	282624
Number of I/O	131
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-20e-5qn208i

PFU Blocks

The core of the LatticeECP2/M device consists of PFU blocks, which are provided in two forms, the PFU and PFF. The PFUs can be programmed to perform Logic, Arithmetic, Distributed RAM and Distributed ROM functions. PFF blocks can be programmed to perform Logic, Arithmetic and ROM functions. Except where necessary, the remainder of this data sheet will use the term PFU to refer to both PFU and PFF blocks.

Each PFU block consists of four interconnected slices, numbered 0-3 as shown in Figure 2-3. All the interconnections to and from PFU blocks are from routing. There are 50 inputs and 23 outputs associated with each PFU block.

Figure 2-3. PFU Diagram



Slice

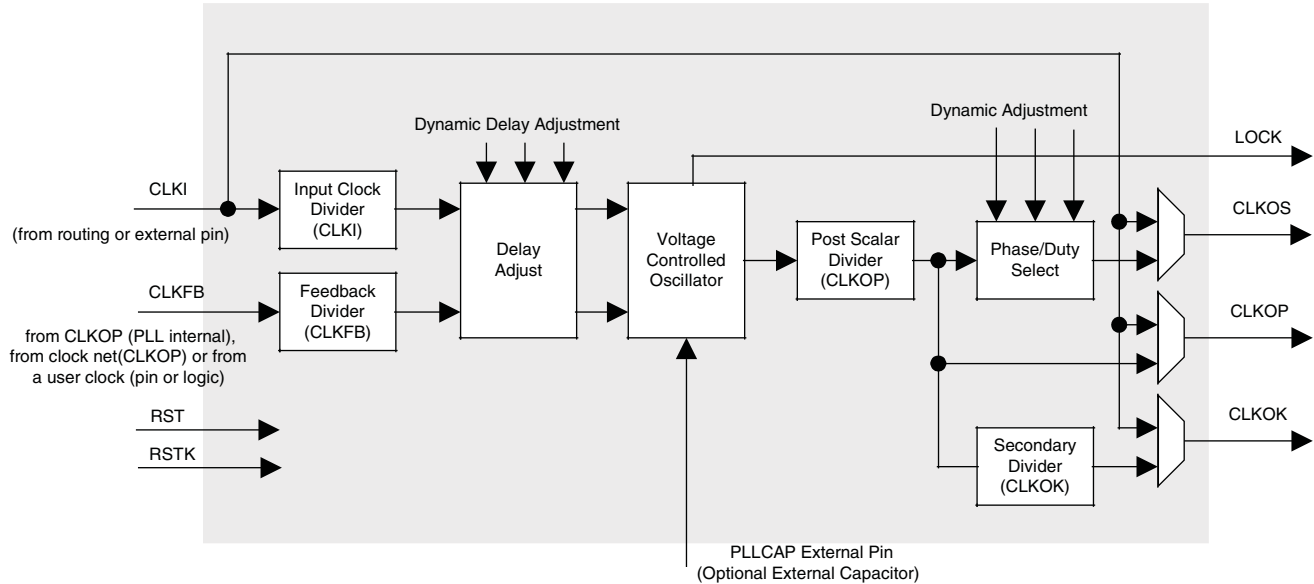
Slice 0 through Slice 2 contain two LUT4s feeding two registers, whereas Slice 3 contains two LUT4s only. For PFUs, Slice 0 and Slice 2 can also be configured as distributed memory, a capability not available in the PFF. Table 2-1 shows the capability of the slices in both PFF and PFU blocks along with the operation modes they enable. In addition, each PFU contains some logic that allows the LUTs to be combined to perform functions such as LUT5, LUT6, LUT7 and LUT8. There is control logic to perform set/reset functions (programmable as synchronous/asynchronous), clock select, chip-select and wider RAM/ROM functions. Figure 2-4 shows an overview of the internal logic of the slice. The registers in the slice can be configured for positive/negative and edge triggered or level sensitive clocks.

Table 2-1. Resources and Modes Available per Slice

Slice	PFU BLock		PFF Block	
	Resources	Modes	Resources	Modes
Slice 0	2 LUT4s and 2 Registers	Logic, Ripple, RAM, ROM	2 LUT4s and 2 Registers	Logic, Ripple, ROM
Slice 1	2 LUT4s and 2 Registers	Logic, Ripple, ROM	2 LUT4s and 2 Registers	Logic, Ripple, ROM
Slice 2	2 LUT4s and 2 Registers	Logic, Ripple, RAM, ROM	2 LUT4s and 2 Registers	Logic, Ripple, ROM
Slice 3	2 LUT4s	Logic, ROM	2 LUT4s	Logic, ROM

Slices 0, 1 and 2 have 14 input signals: 13 signals from routing and one from the carry-chain (from the adjacent slice or PFU). There are seven outputs: six to routing and one to carry-chain (to the adjacent PFU). Slice 3 has 13 input signals from routing and four signals to routing. Table 2-2 lists the signals associated with Slice 0 to Slice 2.

Figure 2-5. General Purpose PLL (GPLL) Diagram



Standard PLL (SPLL)

Some of the larger devices have two to six Standard PLLs (SPLLs). SPLLs have the same features as GPLLs but without delay adjustment capability. SPLLs also provide different parametric specifications. For more information, please see the list of additional technical documentation at the end of this data sheet.

Table 2-4 provides a description of the signals in the GPLL and SPLL blocks.

Table 2-4. GPLL and SPLL Blocks Signal Descriptions

Signal	I/O	Description
CLKI	I	Clock input from external pin or routing
CLKFB	I	PLL feedback input from CLKOP (PLL internal), from clock net (CLKOP) or from a user clock (PIN or logic)
RST	I	"1" to reset PLL counters, VCO, charge pumps and M-dividers
RSTK	I	"1" to reset K-divider
CLKOS	O	PLL output clock to clock tree (phase shifted/duty cycle changed)
CLKOP	O	PLL output clock to clock tree (no phase shift)
CLKOK	O	PLL output to clock tree through secondary clock divider
LOCK	O	"1" indicates PLL LOCK to CLKI
DDAMODE ¹	I	Dynamic Delay Enable. "1": Pin control (dynamic), "0": Fuse Control (static)
DDAIZR ¹	I	Dynamic Delay Zero. "1": delay = 0, "0": delay = on
DDAILAG ¹	I	Dynamic Delay Lag/Lead. "1": Lead, "0": Lag
DDAIDEL[2:0] ¹	I	Dynamic Delay Input
DPA MODES	I	DPA (Dynamic Phase Adjust/Duty Cycle Select) mode
DPHASE [3:0]	I	DPA Phase Adjust inputs
DDDUTY [3:0]	—	DPA Duty Cycle Select inputs

1. These signals are not available in SPLL.

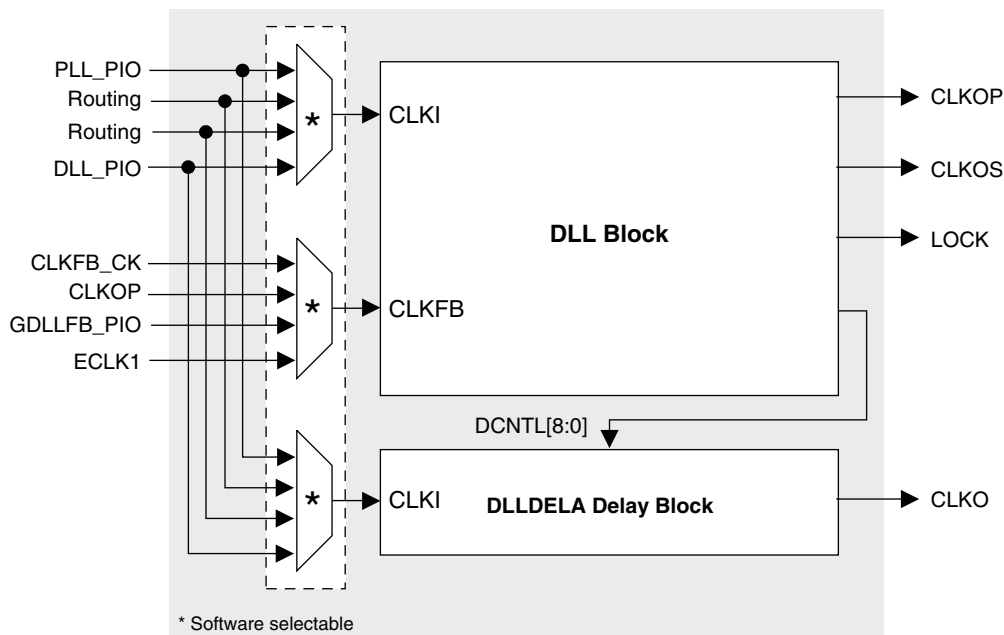
Table 2-5. DLL Signals

Signal	I/O	Description
CLKI	I	Clock input from external pin or routing
CLKFB	I	DLL feed input from DLL output, clock net, routing or external pin
RSTN	I	Active low synchronous reset
ALUHOLD	I	Active high freezes the ALU
UDDCNTL	I	Synchronous enable signal (hold high for two cycles) from routing
DCNTL[8:0]	O	Encoded digital control signals for PIC INDEL and slave delay calibration
CLKOP	O	The primary clock output
CLKOS	O	The secondary clock output with fine phase shift and/or division by 2 or by 4
LOCK	O	Active high phase lock indicator

DLLDELA Delay Block

Closely associated with each DLL is a DLLDELA block. This is a delay block consisting of a delay line with taps and a selection scheme that selects one of the taps. The DCNTL[8:0] bus controls the delay of the CLKO signal. Typically this is the delay setting that the DLL uses to achieve phase alignment. This results in the delay providing a calibrated 90° phase shift that is useful in centering a clock in the middle of a data cycle for source synchronous data. The CLKO signal feeds the edge clock network. Figure 2-7 shows the connections between the DLL block and the DLLDELA delay block. For more information, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-7. DLLDELA Delay Block



PLL/DLL Cascading

LatticeECP2/M devices have been designed to allow certain combinations of PLL (GPLL and SPLL) and DLL cascading. The allowable combinations are:

- PLL to PLL supported
- PLL to DLL supported

Symbol	Parameter	Min.	Max.	Units
V_{CCP}^6	PLL and Reference Clock Buffer Power	1.14	1.26	V

1. If V_{CCIO} or V_{CCJ} is set to 1.2V, they must be connected to the same power supply as V_{CC} . If V_{CCIO} or V_{CCJ} is set to 3.3V, they must be connected to the same power supply as V_{CCAUX} . V_{CCPLL} must be connected to the same power supply as V_{CC} through careful filtering and decoupling.
2. See recommended voltages by I/O standard in subsequent table.
3. V_{CCAUX} ramp rate must not exceed 30mV/ μ s during power-up when transitioning between 0V and 3.3V.
4. For proper power-up configuration, users must ensure that the configuration control signals such as the CFGx, INITN, PROGRAMN and DONE pins are driven to the proper logic levels when the device powers up. The device power-up is triggered by the last of V_{CC} , V_{CCAUX} or V_{CCIO8} supplies that reaches its minimum valid levels. Alternatively, if the configuration control signals are pulled up by V_{CCIO8} , the V_{CCIO8} (configuration I/O bank) voltage must be powered up prior to or at the same time as the last of V_{CC} or V_{CCAUX} reaches its minimum levels.
5. For power-up, V_{CC} must reach its valid minimum value before powering up V_{CCAUX} (LatticeECP2/M "S" version devices only).
6. V_{CCRX} , V_{CCTX} and V_{CCP} must be tied together in each quad and all quads need to be powered up.
7. For more power supply design recommendations, refer to TN1114 [Electrical Recommendations for Lattice SERDES](#).

Hot Socketing Specifications^{1, 2, 3, 4}

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{DK}	Input or I/O leakage current	$0 \leq V_{IN} \leq V_{IH} \text{ (MAX.)}$	—	—	+/-1000	μ A
I_{HDIN}^5	SERDES average input current when device is powered down and inputs are driven		—	—	4	mA

1. V_{CC} , V_{CCAUX} and V_{CCIO} should rise/fall monotonically. V_{CC} and V_{CCPLL} must be connected to the same power supply (applies to ECP2-6, ECP2-12 and ECP2-20 only).
2. $0 \leq V_{CC} \leq V_{CC} \text{ (MAX.)}$, $0 \leq V_{CCIO} \leq V_{CCIO} \text{ (MAX.)}$ or $0 \leq V_{CCAUX} \leq V_{CCAUX} \text{ (MAX.)}$.
3. I_{DK} is additive to I_{PU} , I_{PW} or I_{BH} .
4. LVCMOS and LVTTL only.
5. Assumes that the device is powered down with all supplies grounded, both P and N inputs driven by a CML driver with maximum allowed V_{CCIB} of 1.575V, 8b10b data and internal AC coupling.

ESD Performance

Please refer to [LatticeECP2/M Product Family Qualification Summary](#) for complete qualification data, including ESD performance.

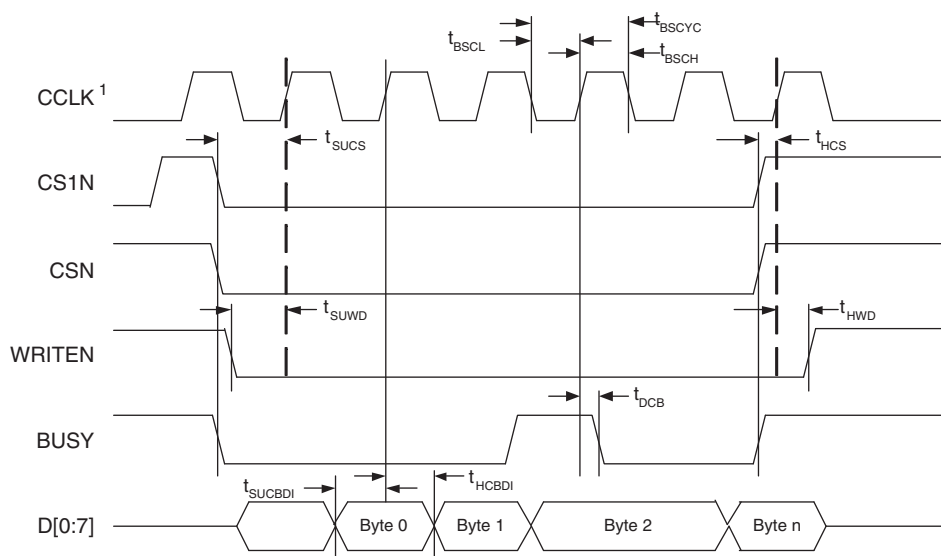
LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t _{DIBSPI}	Data Invalid Before Clock (Transmit)	ECP2-20	—	280	—	280	—	280	ps
		ECP2-35	—	280	—	280	—	280	ps
		ECP2-50	—	280	—	280	—	280	ps
		ECP2-70	—	280	—	280	—	280	ps
		ECP2M20	—	230	—	230	—	230	ps
		ECP2M35	—	230	—	230	—	230	ps
		ECP2M50	—	230	—	230	—	230	ps
		ECP2M70	—	230	—	230	—	230	ps
		ECP2M100	—	230	—	230	—	230	ps
XGMII I/O Pin Parameters (312 Mbps) ⁵									
t _{SUXGMII}	Data Setup Before Read Clock	ECP2/M	480	—	480	—	480	—	ps
t _{HXGMII}	Data Hold After Read Clock	ECP2/M	480	—	480	—	480	—	ps
t _{DVBCKXGMII}	Data Valid Before Clock	ECP2/M	960	—	960	—	960	—	ps
t _{DVACKXGMII}	Data Valid After Clock	ECP2/M	960	—	960	—	960	—	ps
Primary									
f _{MAX_PRI} ⁷	Frequency for Primary Clock Tree	ECP2/M	—	420	—	357	—	311	MHz
t _{W_PRI}	Clock Pulse Width for Primary Clock	ECP2/M	0.95	—	1.19	—	2.00	—	ns
t _{SKEW_PRI}	Primary Clock Skew Within a Bank	ECP2/M	—	300	—	360	—	420	ps
Edge Clock									
f _{MAX_EDGE} ⁷	Frequency for Edge Clock	ECP2/M	—	420	—	357	—	311	MHz
t _{W_EDGE}	Clock Pulse Width for Edge Clock	ECP2/M	0.95	—	1.19	—	2.00	—	ns
t _{SKEW_EDGE}	Edge Clock Skew Within an Edge of the Device	ECP2/M	—	300	—	360	—	420	ps

- General timing numbers based on LVCMOS 2.5, 12mA, 0pf load.
- DDR timing numbers based on SSTL25 for BGA packages only.
- DDR2 timing numbers based on SSTL18 for BGA packages only.
- SPI4.2 and SFI4 timing numbers based on LVDS25 for BGA packages only.
- XGMII timing numbers based on HSTL class I. A corresponding left/right dedicated clock buffer is used when using the SPI4.2 interface to the left or right edge of the device. For SPI4.2 mode, the software tool will help in selecting the appropriate clock buffer.
- IP will be used to support DDR and DDR2 memory data rates down to 95MHz. This approach uses a free-running clock and PFU register to sample the data instead of the hardwired DDR memory interface.
- Using the LVDS I/O standard.
- ECP2-6 and ECP2-12 do not support SPI4.2
- The AC numbers do not apply to PCLK6 and PCLK7.
- Applies to CLKOP only.
- Please refer to TN1159, [LatticeECP2/M Pin Assignment Recommendations](#) for best performance.

Figure 3-15. sysCONFIG Parallel Port Write Cycle



1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

Figure 3-16. sysCONFIG Slave Serial Port Timing

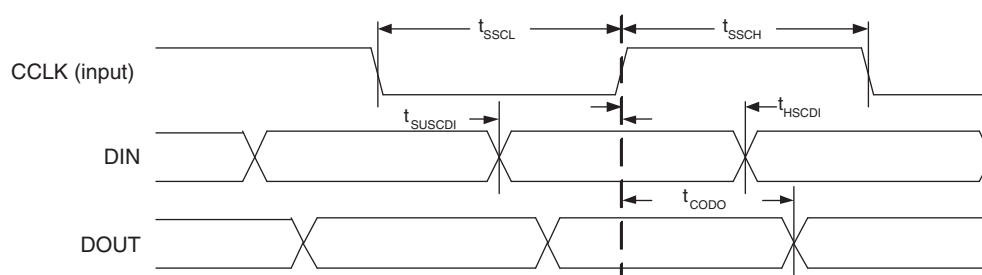
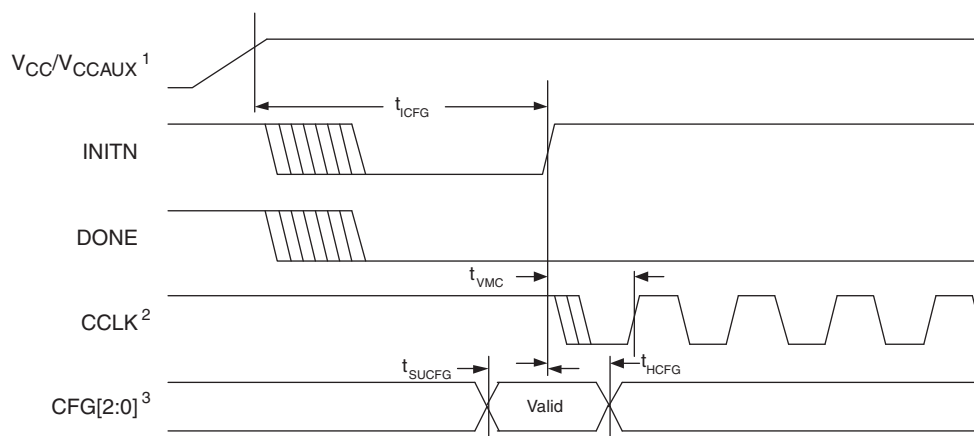


Figure 3-17. Power-On-Reset (POR) Timing



1. Time taken from V_{CC} or V_{CCAUX} , whichever is the last to reach its V_{MIN} .
2. Device is in a Master Mode.
3. The CFG pins are normally static (hard wired).

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP

LFE2-6E/SE					LFE2-12E/12SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
1	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*	
2	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*	
3	PL4A	7		T (LVDS)*	PL4A	7		T (LVDS)*	
4	PL4B	7		C (LVDS)*	PL4B	7		C (LVDS)*	
5	PL6A	7	LDQ10	T (LVDS)*	PL6A	7	LDQ10	T (LVDS)*	
6	VCCAUX	-			VCCAUX	-			
7	PL6B	7	LDQ10	C (LVDS)*	PL6B	7	LDQ10	C (LVDS)*	
8	PL8A	7	LDQ10	T (LVDS)*	PL8A	7	LDQ10	T (LVDS)*	
9	VCCIO7	7			VCCIO7	7			
10	PL8B	7	LDQ10	C (LVDS)*	PL8B	7	LDQ10	C (LVDS)*	
11	GND	-			GND	-			
12	PL12A	7	LDQ10	T (LVDS)*	PL12A	7	LDQ10	T (LVDS)*	
13	PL12B	7	LDQ10	C (LVDS)*	PL12B	7	LDQ10	C (LVDS)*	
14	PL13A	7	PCLKT7_0/LDQ10	T	PL13A	7	PCLKT7_0/LDQ10	T	
15	PL13B	7	PCLKC7_0/LDQ10	C	PL13B	7	PCLKC7_0/LDQ10	C	
16	VCC	-			VCC	-			
17	PL15A	6	PCLKT6_0	T (LVDS)*	PL15A	6	PCLKT6_0	T (LVDS)*	
18	PL15B	6	PCLKC6_0	C (LVDS)*	PL15B	6	PCLKC6_0	C (LVDS)*	
19	PL16A	6	VREF2_6	T	PL16A	6	VREF2_6	T	
20	PL16B	6	VREF1_6	C	PL16B	6	VREF1_6	C	
21	GND	-			GND	-			
22	VCC	-			VCC	-			
23	PL18A	6	LLM0_GDLLT_FB_A	T	PL18A	6	LLM0_GDLLT_FB_A	T	
24	PL18B	6	LLM0_GDLLC_FB_A	C	PL18B	6	LLM0_GDLLC_FB_A	C	
25	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
26	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	
27	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	
28	PL22A	6			PL22A	6			
29	VCC	-			VCC	-			
30	GND	-			GND	-			
31	VCCIO6	6			VCCIO6	6			
32	TCK	-			TCK	-			
33	TDI	-			TDI	-			
34	TDO	-			TDO	-			
35	VCCJ	-			VCCJ	-			
36	TMS	-			TMS	-			
37	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T	
38	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C	
39	VCCAUX	-			VCCAUX	-			
40	PB4A	5	BDQ6	T	PB6A	5	BDQS6	T	
41	PB4B	5	BDQ6	C	PB6B	5	BDQ6	C	
42	VCCIO5	5			VCCIO5	5			
43	PB6A	5	BDQS6	T	PB12A	5	BDQ15	T	
44	PB6B	5	BDQ6	C	PB12B	5	BDQ15	C	
45	NC	5			PB16A	5	BDQ15	T	

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
1	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*	
2	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*	
3	PL4A	7		T (LVDS)*	PL6A	7	LDQ8	T (LVDS)*	
4	PL4B	7		C (LVDS)*	PL6B	7	LDQ8	C (LVDS)*	
5	GND	-			GND	-			
6	PL6A	7	LDQ10	T (LVDS)*	PL12A	7	LDQ16	T (LVDS)*	
7	VCCAUX	-			VCCAUX	-			
8	PL6B	7	LDQ10	C (LVDS)*	PL12B	7	LDQ16	C (LVDS)*	
9	PL8A	7	LDQ10	T (LVDS)*	PL14A	7	LDQ16	T (LVDS)*	
10	VCCIO7	7			VCCIO7	7			
11	PL8B	7	LDQ10	C (LVDS)*	PL14B	7	LDQ16	C (LVDS)*	
12	VCC	-			VCC	-			
13	GND	-			GND	-			
14	VCCIO7	7			VCCIO7	7			
15	PL12A	7	LDQ10	T (LVDS)*	PL18A	7	LDQ16	T (LVDS)*	
16	PL12B	7	LDQ10	C (LVDS)*	PL18B	7	LDQ16	C (LVDS)*	
17	GND	-			GND	-			
18	PL13A	7	PCLKT7_0/LDQ10	T	PL19A	7	PCLKT7_0/LDQ16	T	
19	VCC	-			VCC	-			
20	PL13B	7	PCLKC7_0/LDQ10	C	PL19B	7	PCLKC7_0/LDQ16	C	
21	PL15A	6	PCLKT6_0	T (LVDS)*	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*	
22	PL15B	6	PCLKC6_0	C (LVDS)*	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*	
23	PL16A	6	VREF2_6	T	PL22A	6	VREF2_6/LDQ25	T	
24	PL16B	6	VREF1_6	C	PL22B	6	VREF1_6/LDQ25	C	
25	GND	-			GND	-			
26	PL17A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*	
27	PL17B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*	
28	VCC	-			VCC	-			
29	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
30	VCCAUX	-			VCCAUX	-			
31	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*	
32	GND	-			GND	-			
33	PL21A	6	LLM0_GPLLT_FB_A	T	PL31A	6	LLM0_GPLLT_FB_A/LDQ34	T	
34	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL30B	6	LLM0_GPLLC_IN_A**/LDQ34	C (LVDS)*	
35	PL21B	6	LLM0_GPLLC_FB_A	C	PL31B	6	LLM0_GPLLC_FB_A/LDQ34	C	
36	PL23A	6			PL33A	6	LDQ34		
37	PL24A	6	LDQ28	T (LVDS)*	PL38A	6	LDQ42	T (LVDS)*	
38	VCCIO6	6			VCCIO6	6			
39	PL24B	6	LDQ28	C (LVDS)*	PL38B	6	LDQ42	C (LVDS)*	
40	VCC	-			VCC	-			
41	PL26A	6	LDQ28	T (LVDS)*	PL40A	6	LDQ42	T (LVDS)*	
42	GND	-			GND	-			
43	PL26B	6	LDQ28	C (LVDS)*	PL40B	6	LDQ42	C (LVDS)*	
44	VCCIO6	6			VCCIO6	6			
45	PL28A	6	LDQS28	T (LVDS)*	PL42A	6	LDQS42	T (LVDS)*	

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
H16	NC	-			NC	-		
H20	NC	-			NC	-		
H18	NC	-			NC	-		
K6	NC	-			NC	-		
J16	NC	-			NC	-		
N18	VCC	-			VCC	-		
N6	VCC	-			VCC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K1	PL23B	7	LDQ22	C	PL42B	7	LDQ41	C
L4	PL24A	7	LDQ22	T (LVDS)*	PL43A	7	LDQ41	T (LVDS)*
L3	PL24B	7	LDQ22	C (LVDS)*	PL43B	7	LDQ41	C (LVDS)*
L2	PL25A	7	PCLKT7_0/LDQ22	T	PL44A	7	PCLKT7_0/LDQ41	T
GNDIO	GNDIO7	-			GNDIO7	-		
L1	PL25B	7	PCLKC7_0/LDQ22	C	PL44B	7	PCLKC7_0/LDQ41	C
M5	PL27A	6	PCLKT6_0/LDQ31	T (LVDS)*	PL46A	6	PCLKT6_0/LDQ50	T (LVDS)*
M6	PL27B	6	PCLKC6_0/LDQ31	C (LVDS)*	PL46B	6	PCLKC6_0/LDQ50	C (LVDS)*
M3	PL28A	6	VREF2_6/LDQ31	T	PL47A	6	VREF2_6/LDQ50	T
M4	PL28B	6	VREF1_6/LDQ31	C	PL47B	6	VREF1_6/LDQ50	C
M2	PL29A	6	LDQ31	T (LVDS)*	PL48A	6	LDQ50	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO	6		
M1	PL29B	6	LDQ31	C (LVDS)*	PL48B	6	LDQ50	C (LVDS)*
N1	PL30A	6	LDQ31	T	PL49A	6	LDQ50	T
N2	PL30B	6	LDQ31	C	PL49B	6	LDQ50	C
GNDIO	GNDIO6	-			GNDIO6	-		
VCCIO	VCCIO6	6			VCCIO	6		
N3	PL39A	6	LDQS39***	T (LVDS)*	PL58A	6	LDQS58***	T (LVDS)*
N4	PL39B	6	LDQ39	C (LVDS)*	PL58B	6	LDQ58	C (LVDS)*
N5	PL40A	6	LDQ39	T	PL59A	6	LDQ58	T
VCCIO	VCCIO6	6			VCCIO	6		
P5	PL40B	6	LDQ39	C	PL59B	6	LDQ58	C
P1	PL41A	6	LLM0_GDLLT_IN_A**/LDQ39	T (LVDS)*	PL60A	6	LLM0_GDLLT_IN_A**/LDQ58	T (LVDS)*
P2	PL41B	6	LLM0_GDLLC_IN_A**/LDQ39	C (LVDS)*	PL60B	6	LLM0_GDLLC_IN_A**/LDQ58	C (LVDS)*
P4	PL42A	6	LLM0_GDLLT_FB_A/LDQ39	T	PL61A	6	LLM0_GDLLT_FB_A/LDQ58	T
GNDIO	GNDIO6	-			GNDIO6	-		
R4	PL42B	6	LLM0_GDLLC_FB_A/LDQ39	C	PL61B	6	LLM0_GDLLC_FB_D/LDQ58	C
P6	LLM0_PLLCAP	6			LLM0_PLLCAP	6		
R1	PL44A	6	LLM0_GPLLT_IN_A**/LDQ48	T (LVDS)*	PL63A	6	LLM0_GPLLT_IN_A**/LDQ67	T (LVDS)*
R2	PL44B	6	LLM0_GPLLC_IN_A**/LDQ48	C (LVDS)*	PL63B	6	LLM0_GPLLC_IN_A**/LDQ67	C (LVDS)*
R3	PL45A	6	LLM0_GPLLT_FB_A/LDQ48	T	PL64A	6	LLM0_GPLLT_FB_A/LDQ67	T
T4	PL45B	6	LLM0_GPLLC_FB_A/LDQ48	C	PL64B	6	LLM0_GPLLC_FB_A/LDQ67	C
T1	PL46A	6	LDQ48	T (LVDS)*	PL65A	6	LDQ67	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO	6		
T2	PL46B	6	LDQ48	C (LVDS)*	PL65B	6	LDQ67	C (LVDS)*
T5	PL47A	6	LDQ48	T	PL66A	6	LDQ67	T
T3	PL47B	6	LDQ48	C	PL66B	6	LDQ67	C
GNDIO	GNDIO6	-			VCCIO	6		
VCCIO	VCCIO6	-			GNDIO6	-		
U1	PL52A	6	LDQ56	T (LVDS)*	PL71A	6	LDQ75	T (LVDS)*
U2	PL52B	6	LDQ56	C (LVDS)*	PL71B	6	LDQ75	C (LVDS)*
V1	PL53A	6	LDQ56	T	PL72A	6	LDQ75	T
V2	PL53B	6	LDQ56	C	PL72B	6	LDQ75	C
VCCIO	VCCIO6	6			VCCIO	6		
R6	PL54A	6	LDQ56	T (LVDS)*	PL73A	6	LDQ75	T (LVDS)*
T6	PL54B	6	LDQ56	C (LVDS)*	PL73B	6	LDQ75	C (LVDS)*

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N16	VCCIO3	3			VCCIO3	3		
P16	VCCIO3	3			VCCIO3	3		
R14	VCCIO4	4			VCCIO4	4		
T12	VCCIO4	4			VCCIO4	4		
T13	VCCIO4	4			VCCIO4	4		
T14	VCCIO4	4			VCCIO4	4		
R9	VCCIO5	5			VCCIO5	5		
T10	VCCIO5	5			VCCIO5	5		
T11	VCCIO5	5			VCCIO5	5		
T9	VCCIO5	5			VCCIO5	5		
N7	VCCIO6	6			VCCIO6	6		
P7	VCCIO6	6			VCCIO6	6		
P8	VCCIO6	6			VCCIO6	6		
R8	VCCIO6	6			VCCIO6	6		
J8	VCCIO7	7			VCCIO7	7		
K7	VCCIO7	7			VCCIO7	7		
L7	VCCIO7	7			VCCIO7	7		
M7	VCCIO7	7			VCCIO7	7		
P15	VCCIO8	8			VCCIO8	8		
R15	VCCIO8	8			VCCIO8	8		
A22	GND	-			GND	-		
AA19	GND	-			GND	-		
AA4	GND	-			GND	-		
AB1	GND	-			GND	-		
AB22	GND	-			GND	-		
B19	GND	-			GND	-		
B4	GND	-			GND	-		
C14	GND	-			GND	-		
C9	GND	-			GND	-		
D2	GND	-			GND	-		
D21	GND	-			GND	-		
F17	GND	-			GND	-		
F6	GND	-			GND	-		
H10	GND	-			GND	-		
H11	GND	-			GND	-		
H12	GND	-			GND	-		
H13	GND	-			GND	-		
J14	GND	-			GND	-		
J20	GND	-			GND	-		
J3	GND	-			GND	-		
J9	GND	-			GND	-		
K10	GND	-			GND	-		
K11	GND	-			GND	-		
K12	GND	-			GND	-		
K13	GND	-			GND	-		
K15	GND	-			GND	-		

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L2	NC	-			NC	-		
L1	NC	-			NC	-		
VCCIO	VCCIO7	7			VCCIO7	7		
M2	NC	-			NC	-		
M1	NC	-			NC	-		
N2	NC	-			NC	-		
GND	GNDIO7	-			GNDIO7	-		
M8	VCC	-			NC	-		
VCCIO	VCCIO7	7			VCCIO7	7		
GND	GNDIO7	-			GNDIO7	-		
N1	PL12A	7	LDQ16		PL18A	7	LDQ22	
L8	PL13A	7	LDQ16	T	PL19A	7	LDQ22	T
K8	PL13B	7	LDQ16	C	PL19B	7	LDQ22	C
VCCIO	VCCIO7	7			VCCIO7	7		
L6	PL14A	7	LDQ16	T (LVDS)*	PL20A	7	LDQ22	T (LVDS)*
K5	PL14B	7	LDQ16	C (LVDS)*	PL20B	7	LDQ22	C (LVDS)*
L7	PL15A	7	LDQ16	T	PL21A	7	LDQ22	T
L5	PL15B	7	LDQ16	C	PL21B	7	LDQ22	C
GND	GNDIO7	-			GNDIO7	-		
P1	PL16A	7	LDQS16	T (LVDS)*	PL22A	7	LDQS22	T (LVDS)*
P2	PL16B	7	LDQ16	C (LVDS)*	PL22B	7	LDQ22	C (LVDS)*
M6	PL17A	7	LDQ16	T	PL23A	7	LDQ22	T
VCCIO	VCCIO7	7			VCCIO7	7		
N8	PL17B	7	LDQ16	C	PL23B	7	LDQ22	C
R1	PL18A	7	LDQ16	T (LVDS)*	PL24A	7	LDQ22	T (LVDS)*
R2	PL18B	7	LDQ16	C (LVDS)*	PL24B	7	LDQ22	C (LVDS)*
M7	PL19A	7	PCLKT7_0/LDQ16	T	PL25A	7	PCLKT7_0/LDQ22	T
GND	GNDIO7	-			GNDIO7	-		
N9	PL19B	7	PCLKC7_0/LDQ16	C	PL25B	7	PCLKC7_0/LDQ22	C
M4	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*	PL27A	6	PCLKT6_0/LDQ31	T (LVDS)*
M5	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*	PL27B	6	PCLKC6_0/LDQ31	C (LVDS)*
N7	PL22A	6	VREF2_6/LDQ25	T	PL28A	6	VREF2_6/LDQ31	T
P9	PL22B	6	VREF1_6/LDQ25	C	PL28B	6	VREF1_6/LDQ31	C
N3	PL23A	6	LDQ25	T (LVDS)*	PL29A	6	LDQ31	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
N4	PL23B	6	LDQ25	C (LVDS)*	PL29B	6	LDQ31	C (LVDS)*
N5	PL24A	6	LDQ25	T	PL30A	6	LDQ31	T
P7	PL24B	6	LDQ25	C	PL30B	6	LDQ31	C
T1	NC	-			PL31A	6	LDQS31	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
T2	NC	-			PL31B	6	LDQ31	C (LVDS)*
P8	NC	-			PL32A	6	LDQ31	T
P6	NC	-			PL32B	6	LDQ31	C
VCCIO	VCCIO6	6			VCCIO6	6		
P5	NC	-			PL33A	6	LDQ31	T (LVDS)*
P4	NC	-			PL33B	6	LDQ31	C (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AJ6	PB16A	5	BDQ15	T
AK6	PB16B	5	BDQ15	C
VCCIO	VCCIO5	5		
GND	GNDIO5	-		
AD10	PB29A	5	BDQ33	T
AF10	PB29B	5	BDQ33	C
AC11	PB30A	5	BDQ33	T
AD11	PB30B	5	BDQ33	C
AG9	PB31A	5	BDQ33	T
AH9	PB31B	5	BDQ33	C
VCCIO	VCCIO5	99		
AE11	PB32A	5	BDQ33	T
AG10	PB32B	5	BDQ33	C
GND	GNDIO5	-		
AJ9	PB33A	5	BDQS33	T
AK9	PB33B	5	BDQ33	C
AF11	PB34A	5	BDQ33	T
AH10	PB34B	5	BDQ33	C
AC12	PB35A	5	BDQ33	T
AE12	PB35B	5	BDQ33	C
VCCIO	VCCIO5	5		
AD12	PB36A	5	BDQ33	T
AF12	PB36B	5	BDQ33	C
AJ10	PB37A	5	BDQ33	T
AK10	PB37B	5	BDQ33	C
GND	GNDIO5	-		
AG11	PB38A	5	BDQ42	T
AH11	PB38B	5	BDQ42	C
AE13	PB39A	5	BDQ42	T
AC13	PB39B	5	BDQ42	C
AF13	PB40A	5	BDQ42	T
VCCIO	VCCIO5	5		
AD13	PB40B	5	BDQ42	C
AJ11	PB41A	5	BDQ42	T
AK11	PB41B	5	BDQ42	C
AD14	PB42A	5	BDQS42	T
GND	GNDIO5	-		
AC14	PB42B	5	BDQ42	C
AG12	PB43A	5	BDQ42	T
AE14	PB43B	5	BDQ42	C
AJ12	PB44A	5	BDQ42	T
VCCIO	VCCIO5	5		
AK12	PB44B	5	BDQ42	C

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C17	PT58B	1		C
A18	PT58A	1		T
VCCIO	VCCIO1	1		
H16	PT57B	1	PCLKC1_0	C
F16	PT57A	1	PCLKT1_0	T
K16	XRES	1		
E16	PT55B	0	PCLKC0_0	C
GND	GNDIO0	-		
G16	PT55A	0	PCLKT0_0	T
B17	PT54B	0		C
A17	PT54A	0		T
J15	PT53B	0		C
VCCIO	VCCIO0	0		
J16	PT53A	0		T
C16	PT52B	0		C
D16	PT52A	0		T
F15	PT51B	0		C
H15	PT51A	0		T
E15	PT50B	0		C
GND	GNDIO0	-		
G15	PT50A	0		T
C15	PT49B	0		C
VCCIO	VCCIO0	0		
D15	PT49A	0		T
B16	PT48B	0		C
A16	PT48A	0		T
E14	PT47B	0		C
G14	PT47A	0		T
B15	PT46B	0		C
A15	PT46A	0		T
GND	GNDIO0	-		
H14	PT45B	0		C
F14	PT45A	0		T
D14	PT44B	0		C
C14	PT44A	0		T
VCCIO	VCCIO0	0		
G13	PT43B	0		C
E13	PT43A	0		T
B14	PT42B	0		C
A14	PT42A	0		T
GND	GNDIO0	-		
H13	PT41B	0		C
F13	PT41A	0		T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
E27	NC	-		
E28	NC	-		
E29	NC	-		
E3	NC	-		
E30	NC	-		
E4	NC	-		
E5	NC	-		
E6	NC	-		
F25	NC	-		
F5	NC	-		
F6	NC	-		
G6	NC	-		
G7	NC	-		
K10	NC	-		
K9	NC	-		
N27	NC	-		
N4	NC	-		
R1	NC	-		
R2	NC	-		
V27	NC	-		
V4	NC	-		
P22	VCCPLL	-		
P8	VCCPLL	-		
T22	VCCPLL	-		
Y7	VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
GNDIO	GNDIO0	-			GNDIO0	-			
F7	PT9B	0		C	PT9B	0		C	
G7	PT9A	0		T	PT9A	0		T	
C3	PT8B	0		C	PT8B	0		C	
D4	PT8A	0		T	PT8A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
F6	PT7B	0		C	PT7B	0		C	
E6	PT7A	0		T	PT7A	0		T	
E5	PT6B	0		C	PT6B	0		C	
D6	PT6A	0		T	PT6A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
D3	PT5B	0		C	PT5B	0		C	
E3	PT5A	0		T	PT5A	0		T	
D5	PT4B	0		C	PT4B	0		C	
E4	PT4A	0		T	PT4A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
C2	PT3B	0		C	PT3B	0		C	
B2	PT3A	0		T	PT3A	0		T	
B1	PT2B	0		C	PT2B	0		C	
C1	PT2A	0		T	PT2A	0		T	
R8	VCCPLL	-			VCCPLL	-			
H15	VCCPLL	-			VCCPLL	-			
H8	VCCPLL	-			VCCPLL	-			
R15	VCCPLL	-			VCCPLL	-			
J10	VCC	-			VCC	-			
J11	VCC	-			VCC	-			
J12	VCC	-			VCC	-			
J13	VCC	-			VCC	-			
K14	VCC	-			VCC	-			
K9	VCC	-			VCC	-			
L14	VCC	-			VCC	-			
L9	VCC	-			VCC	-			
M14	VCC	-			VCC	-			
M9	VCC	-			VCC	-			
N14	VCC	-			VCC	-			
N9	VCC	-			VCC	-			
P10	VCC	-			VCC	-			
P11	VCC	-			VCC	-			
P12	VCC	-			VCC	-			
P13	VCC	-			VCC	-			
B5	VCCIO0	0			VCCIO0	0			
B9	VCCIO0	0			VCCIO0	0			
E7	VCCIO0	0			VCCIO0	0			
H9	VCCIO0	0			VCCIO0	0			
D13	VCCIO1	1			VCCIO1	1			
E16	VCCIO1	1			VCCIO1	1			
H14	VCCIO1	1			VCCIO1	1			
E21	VCCIO2	2			VCCIO2	2			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AJ2	LLC_SQ_HDINN3	14		C
AH4	LLC_SQ_VCCTX3	14		
AK5	LLC_SQ_HDOUTP3	14		T
AK4	LLC_SQ_VCCOB3	14		
AJ5	LLC_SQ_HDOUTN3	14		C
AH5	LLC_SQ_VCCTX2	14		
AJ6	LLC_SQ_HDOUTN2	14		C
AH6	LLC_SQ_VCCOB2	14		
AK6	LLC_SQ_HDOUTP2	14		T
AH2	LLC_SQ_VCCR2	14		
AJ3	LLC_SQ_HDINN2	14		C
AH3	LLC_SQ_VCCIB2	14		
AK3	LLC_SQ_HDINP2	14		T
AH7	LLC_SQ_VCCP	14		
AG7	LLC_SQ_REFCLKP	14		T
AF7	LLC_SQ_REFCLKN	14		C
AJ7	LLC_SQ_VCCAUX33	14		
AK11	LLC_SQ_HDINP1	14		T
AH11	LLC_SQ_VCCIB1	14		
AJ11	LLC_SQ_HDINN1	14		C
AH12	LLC_SQ_VCCR1	14		
AK8	LLC_SQ_HDOUTP1	14		T
AH8	LLC_SQ_VCCOB1	14		
AJ8	LLC_SQ_HDOUTN1	14		C
AH9	LLC_SQ_VCCTX1	14		
AJ9	LLC_SQ_HDOUTN0	14		C
AK10	LLC_SQ_VCCOB0	14		
AK9	LLC_SQ_HDOUTP0	14		T
AH10	LLC_SQ_VCCTX0	14		
AJ12	LLC_SQ_HDINN0	14		C
AJ13	LLC_SQ_VCCIB0	14		
AK12	LLC_SQ_HDINP0	14		T
AH13	LLC_SQ_VCCR0	14		
AF10	PB30A	5	BDQ33	T
AE8	PB30B	5	BDQ33	C
AE11	PB31A	5	BDQ33	T
VCCIO	VCCIO5	5		
AD9	PB31B	5	BDQ33	C
AE10	PB32A	5	BDQ33	T
AD10	PB32B	5	BDQ33	C
AE13	PB33A	5	BDQS33	T
GNDIO	GNDIO5	-		
AC12	PB33B	5	BDQ33	C

LatticeECP2 S-Series Devices, Lead-Free Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6SE-5TN144C	90	1.2V	-5	Lead-Free TQFP	144	Com	6
LFE2-6SE-6TN144C	90	1.2V	-6	Lead-Free TQFP	144	Com	6
LFE2-6SE-7TN144C	90	1.2V	-7	Lead-Free TQFP	144	Com	6
LFE2-6SE-5FN256C	190	1.2V	-5	Lead-Free fpBGA	256	Com	6
LFE2-6SE-6FN256C	190	1.2V	-6	Lead-Free fpBGA	256	Com	6
LFE2-6SE-7FN256C	190	1.2V	-7	Lead-Free fpBGA	256	Com	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12SE-5TN144C	93	1.2V	-5	Lead-Free TQFP	144	Com	12
LFE2-12SE-6TN144C	93	1.2V	-6	Lead-Free TQFP	144	Com	12
LFE2-12SE-7TN144C	93	1.2V	-7	Lead-Free TQFP	144	Com	12
LFE2-12SE-5QN208C	131	1.2V	-5	Lead-Free PQFP	208	Com	12
LFE2-12SE-6QN208C	131	1.2V	-6	Lead-Free PQFP	208	Com	12
LFE2-12SE-7QN208C	131	1.2V	-7	Lead-Free PQFP	208	Com	12
LFE2-12SE-5FN256C	193	1.2V	-5	Lead-Free fpBGA	256	Com	12
LFE2-12SE-6FN256C	193	1.2V	-6	Lead-Free fpBGA	256	Com	12
LFE2-12SE-7FN256C	193	1.2V	-7	Lead-Free fpBGA	256	Com	12
LFE2-12SE-5FN484C	297	1.2V	-5	Lead-Free fpBGA	484	Com	12
LFE2-12SE-6FN484C	297	1.2V	-6	Lead-Free fpBGA	484	Com	12
LFE2-12SE-7FN484C	297	1.2V	-7	Lead-Free fpBGA	484	Com	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20SE-5QN208C	131	1.2V	-5	Lead-Free PQFP	208	Com	20
LFE2-20SE-6QN208C	131	1.2V	-6	Lead-Free PQFP	208	Com	20
LFE2-20SE-7QN208C	131	1.2V	-7	Lead-Free PQFP	208	Com	20
LFE2-20SE-5FN256C	193	1.2V	-5	Lead-Free fpBGA	256	Com	20
LFE2-20SE-6FN256C	193	1.2V	-6	Lead-Free fpBGA	256	Com	20
LFE2-20SE-7FN256C	193	1.2V	-7	Lead-Free fpBGA	256	Com	20
LFE2-20SE-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	Com	20
LFE2-20SE-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	Com	20
LFE2-20SE-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	Com	20
LFE2-20SE-5FN672C	402	1.2V	-5	Lead-Free fpBGA	672	Com	20
LFE2-20SE-6FN672C	402	1.2V	-6	Lead-Free fpBGA	672	Com	20
LFE2-20SE-7FN672C	402	1.2V	-7	Lead-Free fpBGA	672	Com	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20SE-5QN208I	131	1.2V	-5	Lead-Free PQFP	208	Ind	20
LFE2-20SE-6QN208I	131	1.2V	-6	Lead-Free PQFP	208	Ind	20
LFE2-20SE-5FN256I	193	1.2V	-5	Lead-Free fpBGA	256	Ind	20
LFE2-20SE-6FN256I	193	1.2V	-6	Lead-Free fpBGA	256	Ind	20
LFE2-20SE-5FN484I	331	1.2V	-5	Lead-Free fpBGA	484	Ind	20
LFE2-20SE-6FN484I	331	1.2V	-6	Lead-Free fpBGA	484	Ind	20
LFE2-20SE-5FN672I	402	1.2V	-5	Lead-Free fpBGA	672	Ind	20
LFE2-20SE-6FN672I	402	1.2V	-6	Lead-Free fpBGA	672	Ind	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35SE-5FN484I	331	1.2V	-5	Lead-Free fpBGA	484	Ind	35
LFE2-35SE-6FN484I	331	1.2V	-6	Lead-Free fpBGA	484	Ind	35
LFE2-35SE-5FN672I	450	1.2V	-5	Lead-Free fpBGA	672	Ind	35
LFE2-35SE-6FN672I	450	1.2V	-6	Lead-Free fpBGA	672	Ind	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50SE-5FN484I	339	1.2V	-5	Lead-Free fpBGA	484	Ind	50
LFE2-50SE-6FN484I	339	1.2V	-6	Lead-Free fpBGA	484	Ind	50
LFE2-50SE-5FN672I	500	1.2V	-5	Lead-Free fpBGA	672	Ind	50
LFE2-50SE-6FN672I	500	1.2V	-6	Lead-Free fpBGA	672	Ind	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70SE-5FN672I	500	1.2V	-5	Lead-Free fpBGA	672	Ind	70
LFE2-70SE-6FN672I	500	1.2V	-6	Lead-Free fpBGA	672	Ind	70
LFE2-70SE-5FN900I	583	1.2V	-5	Lead-Free fpBGA	900	Ind	70
LFE2-70SE-6FN900I	583	1.2V	-6	Lead-Free fpBGA	900	Ind	70

Date	Version	Section	Change Summary
August 2006 (cont.)	01.1 (cont.)	Pinout Information (cont.)	Added Information on: Available Device Resources per Packaged Device table.
		Ordering Information	Updated ordering part number table to include ECP2-12.
			Updated topside mark drawing.
September 2006	02.0	Multiple	Added information regarding LatticeECP2M support throughout.
September 2006	02.1	DC and Switching Characteristics	Added Receiver Total Jitter Tolerance Specification table.
			Removed power-up requirements for proper configuration footnote in Recommended Operating Conditions table.
December 2006	02.2	Introduction	LatticeECP2M Selection Guide table has been updated.
		Architecture	Figure 2-16. Per Region Secondary Clock Selection has been updated.
			Figure 2-39. Simplified Channel Block Diagram for SERDES and PCS has been updated.
		DC and Switching	Footnotes have been added to Recommended Operating Conditions.
			DC Electrical Characteristics table has been updated.
			Supply Current (Standby) tables have been updated.
			Initialization Supply Current table have been updated.
			Updated timing numbers to include LFE2-12E (rev A 0.08).
		Pinout Information	Updated to include the entire ECP2 device information as well as 256-fpBGA and 484-fpBGA pin information for the ECP2M35E.
		Ordering Information	Updated to include the entire ECP2 and ECP2M device ordering information.
February 2007	02.3	Architecture	Updated EBR Asynchronous Reset section.
March 2007	02.4	DC and Switching Characteristics	Power-sequencing footnotes have been added to the Recommended Operating Conditions. DDR2 performance has been updated to 266MHz.
March 2007	02.5	Introduction	Added "Security Series" to the LatticeECP2 and LatticeECP2M families.
		Architecture	Enhanced Configuration Option section updated.
		DC and Switching	Recommended Operating Conditions table - footnote 4 updated.
		Ordering Information	"Security Series" ordering part numbers added.
April 2007	02.6	Introduction	LatticeECP2M family table has been updated for user I/O counts.
		Ordering Information	LatticeECP2M family ordering part number section has been updated to add 1152-fpBGA package for the ECP2M70 and ECP2M100.
July 2007	02.7	Architecture	Updated text in Ripple Mode section.
		DC and Switching	ECP2/M Supply Current information has been updated. Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLN Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.10). SERDES timing information has been updated. PCI Express timing information has been updated.
		Pinout Information	Added LatticeECP2M20 pinout information.
August 2007	02.8	Introduction	1156-fpBGA package option has been removed from the LatticeECP2M family.
		Architecture	Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration table has been updated.
		DC and Switching	Supply Current (Standby) table has been updated.
			DSP Function timing has been updated.